

Socket A/370 Bonded Fin CPU Fan with Copper Base

StarTech ID: FANTBDURPRO



The cooler a processor is, the more stable and efficient it is. The last thing you want to worry about is your mission-critical computer hardware being crippled by heat and crashes. Enter the StarTech.com FANTBDURPRO, a socket A/370 Bonded Fin CPU Fan with a Copper Base. The copper base allows heat to move quickly to the fins for improved efficiency and smaller size. Not only that, but copper spreads heat more effectively than aluminum, which allows the outer heatsink fins to do more work. Specifically designed for use with AMD Athlon and Duron Socket A processors, Intel Pentium III and Celeron Socket 370 FC-PGA processors of any speed, StarTech.com's FANTBDURPRO with its copper base is the perfect solution for any workspace.

Applications

- AMD Athlon and Duron Socket A processors to 1.1 GHz
- Intel Pentium III and Celeron Socket 370 FC-PGA processors - any speed
- Great for MicroATX form factor motherboards where space is tight

Features

- Copper base for improved efficiency
- Bonded fin construction provides 40% more heat dissipation area than conventional heatsinks with lower wind resistance
- Fins are constructed from 99.95% pure aluminum for a 15% higher heat transfer rate than conventional aluminum heatsinks
- Easy to install clip

Technical Specifications

Warranty	2 Years
General Specifications	0.11 Amp
General Specifications	0.182kg (0.40 lbs)
General Specifications	12 VDC
General Specifications	20 CFM
General Specifications	3-lead TX3Motherboard
General Specifications	35 dBA
General Specifications	4700 RPM
General Specifications	50 x 50 x 15 mm (2 x 2 x 0.6inch)
General Specifications	54,000 hours
General Specifications	62 x 52 x 37 mm (2.5 x 2.1 x 1.5inch)
Shipping (Package) Weight	0.4 lb [0.2 kg]
Included in Package	1 - Socket A/370 Bonded fin CPU Cooler